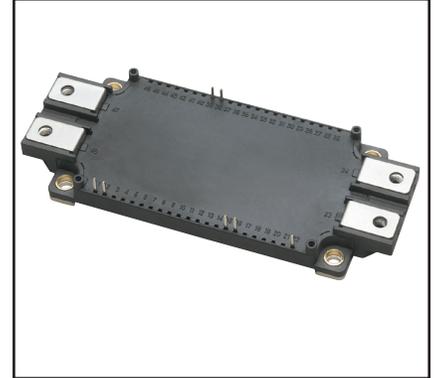
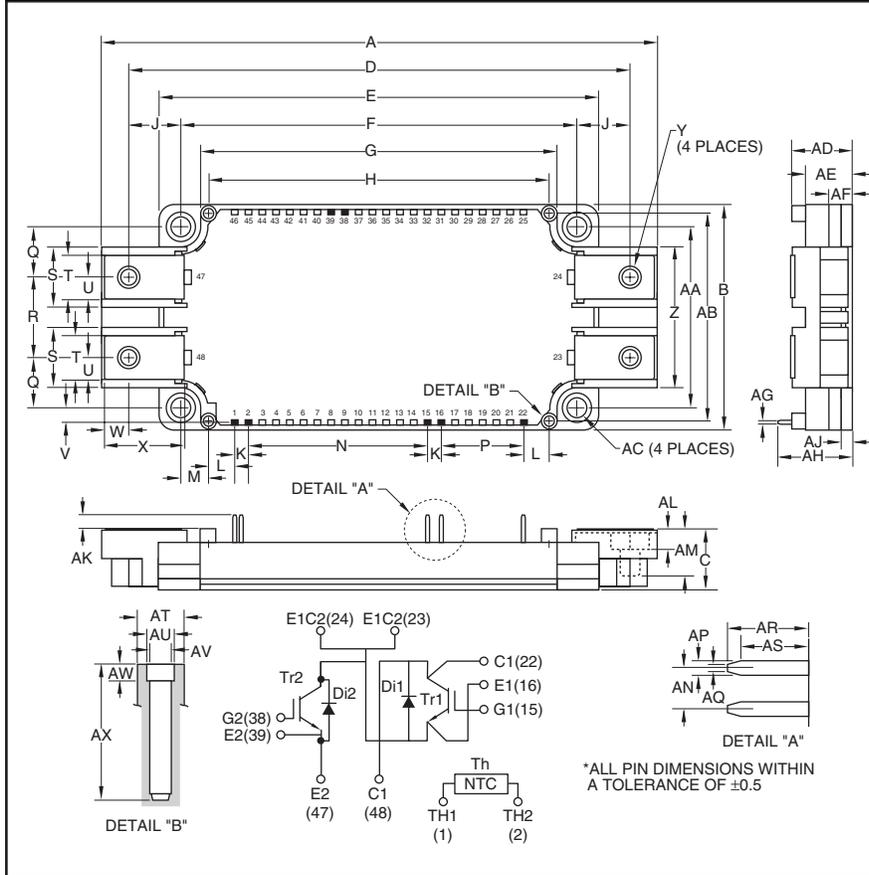


Dual IGBTMOD™ NX-S Series Module 300 Amperes/1200 Volts



Description:

Powerex IGBTMOD™ Modules are designed for use in switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- Photovoltaic/Fuel Cell

Ordering Information:

Example: Select the complete module number you desire from the table below -i.e. CM300DX-24S is a 1200V (V_{CES}), 300 Ampere Dual IGBTMOD™ Power Module.

Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	5.98	152.0
B	2.44	62.0
C	0.67	17.0
D	5.39	137.0
E	4.79	121.7
F	4.33±0.02	110.0±0.5
G	3.89	99.0
H	3.72	94.5
J	0.53	13.5
K	0.15	3.8
L	0.28	7.25
M	0.30	7.75
N	1.95	49.54
P	0.9	22.86
Q	0.55	14.0
R	0.87	22.0
S	0.67	17.0
T	0.48	12.0
U	0.24	6.0
V	0.16	4.2
W	0.37	6.5
X	0.83	21.14
Y	M6	M6

Dimensions	Inches	Millimeters
Z	1.53	39.0
AA	1.97±0.02	50.0±0.5
AB	2.26	57.5
AC	0.22 Dia.	5.5 Dia.
AD	0.67+0.04/-0.02	17.0+1.0/-0.5
AE	0.51	13.0
AF	0.27	7.0
AG	0.03	0.8
AH	0.81	20.5
AJ	0.12	3.0
AK	0.14	3.5
AL	0.21	5.4
AM	0.49	12.5
AN	0.15	3.81
AP	0.05	1.15
AQ	0.025	0.65
AR	0.29	7.4
AS	0.24	6.2
AT	0.17 Dia.	4.3 Dia.
AU	0.10 Dia.	2.5 Dia.
AV	0.08 Dia.	2.1 Dia.
AW	0.06	1.5
AX	0.49	12.5

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	300	24



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CM300DX-24S
Dual IGBTMOD™ NX-S Series Module
300 Amperes/1200 Volts

Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	CM300DX-24S	Units
Maximum Junction Temperature	$T_{j(\max)}$	+175	$^\circ\text{C}$
Operating Power Device Junction Temperature	$T_{j(\text{op})}$	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Mounting Torque, M5 Mounting Screws	—	31	in-lb
Mounting Torque, M6 Main Terminal Screws	—	40	in-lb
Module Weight (Typical)	—	330	Grams
Isolation Voltage (Terminals to Baseplate, $f = 60\text{Hz}$, AC 1 minute)	V_{ISO}	2500	V_{rms}

Inverter Sector

Collector-Emitter Voltage ($V_{\text{GE}} = 0\text{V}$)	V_{CES}	1200	Volts
Gate-Emitter Voltage ($V_{\text{CE}} = 0\text{V}$)	V_{GES}	± 20	Volts
Collector Current (DC, $T_C = 119^\circ\text{C}$) ^{*1,*5}	I_C	300	Amperes
Collector Current (Pulse) ^{*4}	I_{CRM}	600	Amperes
Total Power Dissipation ($T_C = 25^\circ\text{C}$) ^{*1,*5}	P_{tot}	2270	Watts
Emitter Current, Free Wheeling Diode Forward Current ($T_C = 25^\circ\text{C}$) ^{*1,*5}	I_E^{*3}	300	Amperes
Emitter Current, Free Wheeling Diode Forward Current (Pulse) ^{*4}	I_{ERM}^{*3}	600	Amperes

*1 Case temperature (T_C) and heatsink temperature (T_f) measured point is just under the chips.

*3 Represent ratings and characteristics of the anti-parallel, emitter-to-collector free wheeling diode (FWDi).

*4 Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(\max)}$ rating.

*5 Junction temperature (T_j) should not increase beyond maximum junction temperature ($T_{j(\max)}$) rating.

CM300DX-24S
Dual IGBTMOD™ NX-S Series Module
 300 Amperes/1200 Volts

Electrical and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Inverter Sector

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Collector Cutoff Current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$	—	—	1	mA	
Gate Leakage Current	I_{GES}	$\pm V_{GE} = V_{GES}, V_{CE} = 0V$	—	—	0.5	μA	
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 30\text{mA}, V_{CE} = 10V$	5.4	6	6.6	Volts	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$ (Chip)	$I_C = 300A, V_{GE} = 15V, T_j = 25^\circ\text{C}$	—	1.7	2.15	Volts	
		$I_C = 300A, V_{GE} = 15V, T_j = 125^\circ\text{C}$	—	1.9	—	Volts	
		$I_C = 300A, V_{GE} = 15V, T_j = 150^\circ\text{C}$	—	1.95	—	Volts	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$ (Terminal)	$I_C = 300A, V_{GE} = 15V, T_j = 25^\circ\text{C}^{*6}$	—	1.85	2.3	Volts	
		$I_C = 300A, V_{GE} = 15V, T_j = 125^\circ\text{C}^{*6}$	—	2.05	—	Volts	
		$I_C = 300A, V_{GE} = 15V, T_j = 150^\circ\text{C}^{*6}$	—	2.1	—	Volts	
Input Capacitance	C_{ies}		—	—	30	nF	
Output Capacitance	C_{oes}	$V_{GE} = 0V, V_{CE} = 10V$	—	—	6.0	nF	
Reverse Transfer Capacitance	C_{res}		—	—	0.50	nF	
Total Gate Charge	Q_G	$V_{CC} = 600V, I_C = 300A, V_{GE} = 15V$	—	700	—	nC	
Inductive Load	Turn-on Delay Time	$t_{d(on)}$	—	—	800	ns	
	Turn-on Rise Time	t_r	$V_{CC} = 600V, I_C = 300A, ^{*7}$	—	—	200	ns
	Turn-off Delay Time	$t_{d(off)}$	$V_{GE} = \pm 15V,$	—	—	600	ns
	Turn-off Fall Time	t_f	$R_G = 2.7\Omega, \text{ Inductive Load},$ $I_E = 300A$	—	—	300	ns
Reverse Recovery Time	t_{rr}^{*3}		—	—	300	ns	
Reverse Recovery Charge	Q_{rr}^{*3}		—	16	—	μC	
Turn-on Switching Loss per Pulse	E_{on}	$V_{CC} = 600V, I_C (I_E) = 300A, ^{*7}$	—	48	—	mJ	
Turn-off Switching Loss per Pulse	E_{off}	$V_{GE} = \pm 15V, R_G = 2.7\Omega,$	—	32	—	mJ	
Reverse Recovery Loss per Pulse	E_{rec}^{*3}	$T_j = 150^\circ\text{C}, \text{ Inductive Load}$	—	18	—	mJ	
Emitter-Collector Voltage	V_{EC}^{*3} (Chip)	$I_E = 300A, V_{GE} = 0V, T_j = 25^\circ\text{C}$	—	1.7	2.15	Volts	
		$I_E = 300A, V_{GE} = 0V, T_j = 125^\circ\text{C}$	—	1.7	—	Volts	
		$I_E = 300A, V_{GE} = 0V, T_j = 150^\circ\text{C}$	—	1.7	—	Volts	
Emitter-Collector Voltage	V_{EC}^{*3} (Terminal)	$I_E = 300A, V_{GE} = 0V, T_j = 25^\circ\text{C}^{*6}$	—	1.85	2.3	Volts	
		$I_E = 300A, V_{GE} = 0V, T_j = 125^\circ\text{C}^{*6}$	—	1.85	—	Volts	
		$I_E = 300A, V_{GE} = 0V, T_j = 150^\circ\text{C}^{*6}$	—	1.85	—	Volts	

Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case ^{*1}	$R_{th(j-c)Q}$	Per IGBT	—	—	0.66	K/W
Thermal Resistance, Junction to Case ^{*1}	$R_{th(j-c)D}$	Per FWDi	—	—	0.12	K/W
Internal Gate Resistance	r_g	Per Switch	—	6.5	—	Ω

^{*1} Case temperature (T_C) and heatsink temperature (T_H) measured point is just under the chips.

^{*3} Represent ratings and characteristics of the anti-parallel, emitter-to-collector free wheeling diode (FWDi).

^{*6} Pulse width and repetition rate should be such as to cause negligible temperature rise.

^{*7} Recommended maximum collector supply voltage V_{CC} is $800V_{dc}$.



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CM300DX-24S
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NTC Thermistor Sector, T_j = 25°C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Zero Power Resistance	R	T _C = 25°C	4.85	5.00	5.15	kΩ
Deviation of Resistance	ΔR/R	T _C = 100°C, R ₁₀₀ = 493Ω	-7.3	—	+7.8	%
B Constant	B _(25/50)	Approximate by Equation ⁹	—	3375	—	K
Power Dissipation	P ₂₅	T _C = 25°C	—	—	10	mW

Module, T_j = 25°C unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Lead Resistance (Main Terminals-Chip)	R _{lead}	T _C = 25°C (Per Switch)	—	—	0.9	mΩ
Contact Thermal Resistance ^{*1} (Case to Heatsink)	R _{th(c-f)}	Thermal Grease Applied (Per 1 Module) ^{*2}	—	0.015	—	K/W

*1 Case temperature (T_C) and heatsink temperature (T_f) measured point is just under the chips.

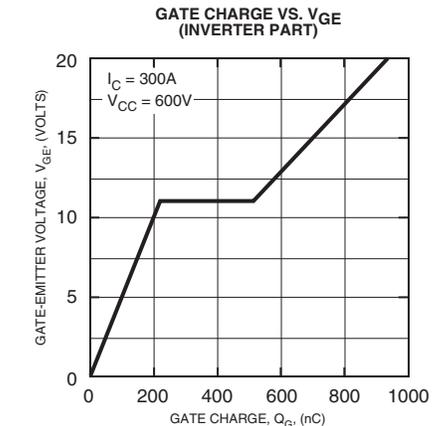
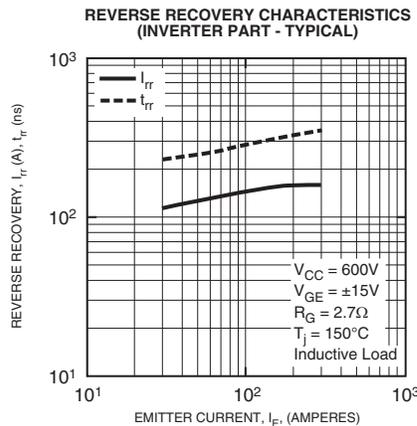
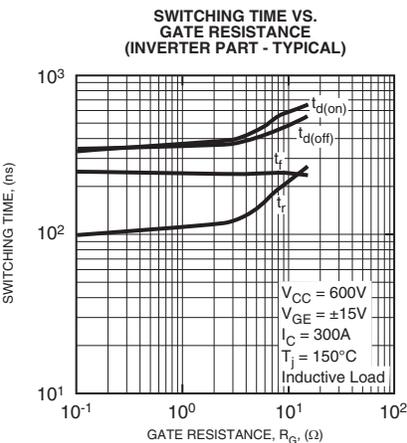
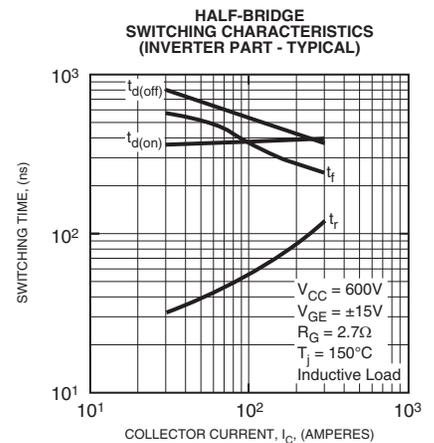
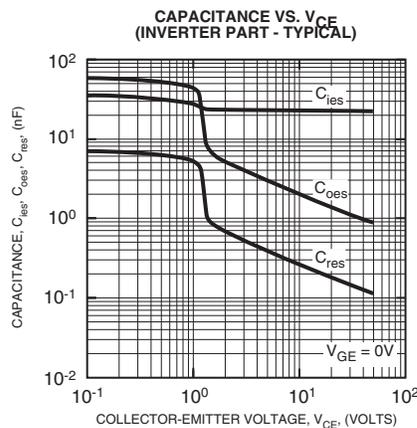
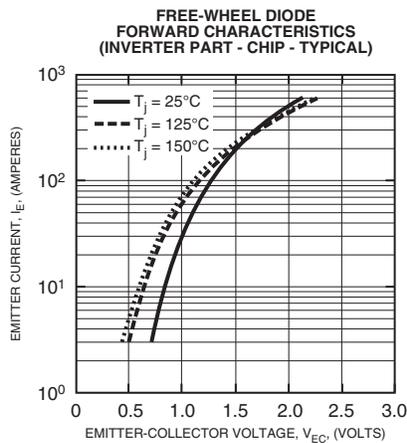
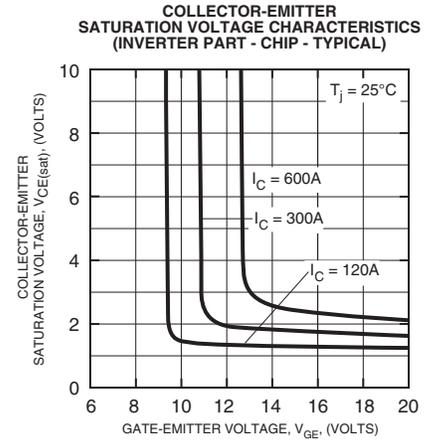
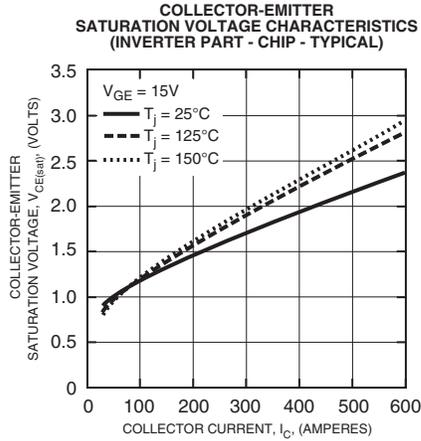
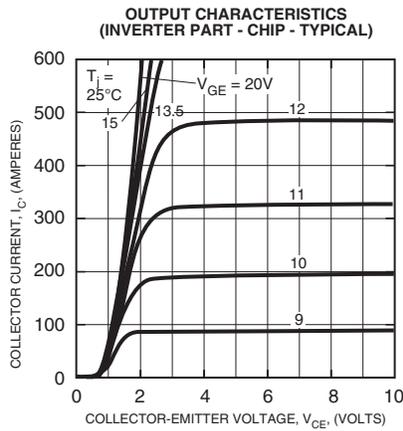
*2 Typical value is measured by using thermally conductive grease of λ = 0.9 [W/(m • K)].

*9 $B_{(25/50)} = \ln\left(\frac{R_{25}}{R_{50}}\right) / \left(\frac{1}{T_{25}} - \frac{1}{T_{50}}\right)$ R₂₅: Resistance at Absolute Temperature T₂₅ [K], R₅₀: resistance at Absolute Temperature T₅₀ [K],
 T₂₅ = 25 [°C] + 273.15 = 298.15 [K], T₅₀ = 50 [°C] + 273.15 = 323.15 [K]



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